multicomp PRO



Features:

- For Surface Mounted Applications
- Low Profile Package
- Built-In Strain Relief
- Metal Silicon Junction, Majority Carrier Conduction
- High Surge Capability
- Low Power Loss, High Efficiency
- For Use in Low Voltage High Frequency Inverters, Free Wheeling and Polarity Protection Applications
- Guardring for Over Voltage Protection
- High Temperature Soldering Guaranteed: 250°C/10 Seconds at Terminals

Mechanical Data

- Case: JEDEC DO-214AC, Molded Plastic over Passivated Chip
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Colour Band Denotes Cathode End
- Weight: 0.002oz, 0.064g

Maximum Ratings and Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified

Characteristic		B340A-13-F	B360A-13-F	Units
Maximum repetitive peak reverse voltage	Vrrm	40	60	V
Maximum RMS voltage	Vrws	28	42	V
Maximum DC blocking voltage	V dc	40	60	V
Maximum average forward rectified current at TL See Fig. 1. (Note 2)	IF(AV)	3		А
Peak forward surge current 8.3ms single half-sine-wave	IFSM	100		А
Maximum instantaneous forward voltage at 3A (Note 1)	VF	0.5	0.7	V
Maximum DC reverse current Ta=25°C at rated DC blocking voltage Ta=100°C (Note 1)	IR	0.5 20		mA
Typical thermal resistance (Note 2)	Røja Røjl	-	0 0	°C/W
Operating junction and storage temperature range	Tj, Tstg	-65 to	+125	°C

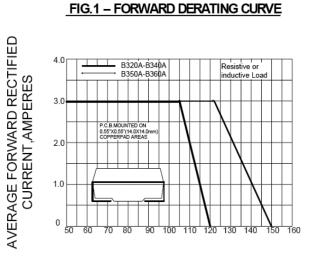
Notes:

(1) Pulse test: 300μ S pulse width, 1% duty cycle.

(2) PCB mounted with 0.55" × 0.55" (14 × 14mm²) copper pad areas.

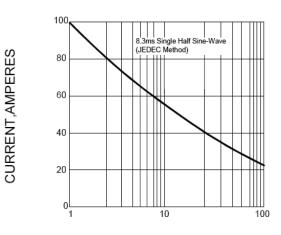
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AMBIENT TEMPERATURE °C

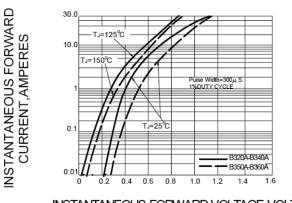
FIG.2- PEAK FORWARD SURGE CURRENT



PEAK FORWARD SURGE

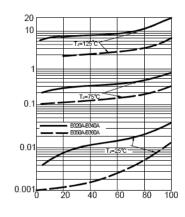
NUMBER OF CYCLES AT 60Hz

FIG.3 -- TYPICAL FORWARD CHARACTERISTICS



INSTANTANEOUS FORWARD VOLTAGE, VOLTS

FIG.4 - TYPICAL REVERSE CHARACTERISTICS

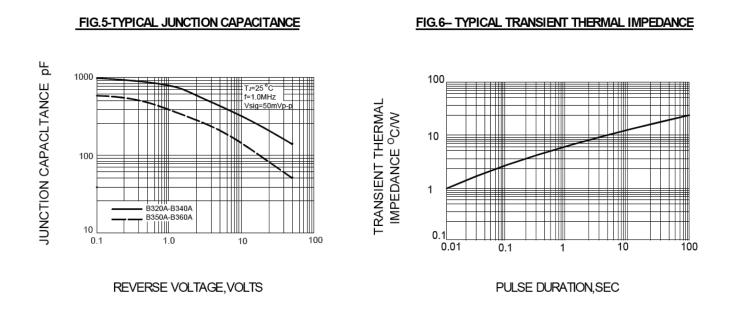


PERCENT OF RATED PEAK REVERSE VOLTAGE, %

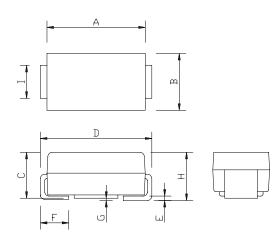
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NSTANTANEOUS REVERSE CURRENT, MILLIAMPERES



Package Outline Dimensions



DO-214AC(SMA)				
Dim.	Min.	Max.		
А	4.25	4.65		
В	2.4	2.8		
С	1.85	2.15		
D	4.85	5.35		
E	0.1	0.3		
F	0.9	1.5		
G	0.2 Max.			
Н	1.9	2.3		
I	1.35	1.65		

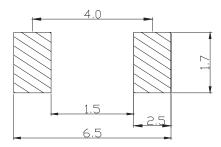
Dimensions : Millimetres

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Soldering Footprint



Dimensions : Millimetres

Package Information

Device	Package	Shipping
B340A-13-F & B360A-13-F	DO-214AC(SMA)	5,000 / Tape & Reel

Part Number Table

Description	Part Number
Schottky Barrier Rectifier	B340A-13-F
	B360A-13-F

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